



#### 60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>C</sub> = +25°C (Note 9)
60V	$3.4\text{m}\Omega$ @ $V_{GS} = 10V$	100A

### **Description**

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

## **Applications**

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

### **Features**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub> Minimizes Power Losses
- Low Q<sub>g</sub> Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMTH6004SCTBQ</u>)

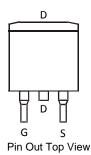
### **Mechanical Data**

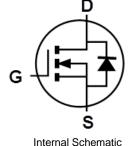
- Case: TO263AB
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 1.7 grams (Approximate)

#### **TO263AB**



Top View





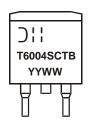
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH6004SCTB-13	TO263AB	800 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



T6004SCTB = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 15 = 2015) WW = Week (01 to 53)



## **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	$V_{DSS}$	60	V	
Gate-Source Voltage	$V_{GSS}$	±20	V	
Continuous Drain Current (Note 6)	T <sub>C</sub> = +25°C (Note 9)	I <sub>D</sub>	100	А
,	T <sub>C</sub> = +100°C		100	
Maximum Continuous Body Diode Forward Current (Note 6)	T <sub>C</sub> = +25°C	Is	100	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle=1%)	I <sub>DM</sub>	200	Α	
Avalanche Current, L=0.2mH	I <sub>AS</sub>	45	Α	
Avalanche Energy, L=0.2mH	E <sub>AS</sub>	200	mJ	

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	$P_{D}$	4.7	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	32	°C/W
Total Power Dissipation (Note 6)	$T_C = +25^{\circ}C$	$P_{D}$	136	W
Thermal Resistance, Junction to Case (Note 6)		R <sub>eJC</sub>	1.1	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +175	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2	-	4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		2.9	3.4	mΩ	$V_{GS} = 10V, I_{D} = 100A$	
Diode Forward Voltage	$V_{SD}$	_	_	1.3	V	$V_{GS} = 0V, I_S = 100A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>iss</sub>	_	4,556	_		V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V f = 1MHz	
Output Capacitance	Coss	1	1,383	_	pF		
Reverse Transfer Capacitance	Crss		105.2	_			
Gate Resistance	$R_g$	_	0.66	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	95.4	_		V <sub>DD</sub> = 30V, I <sub>D</sub> = 90A, V <sub>GS</sub> = 10V	
Gate-Source Charge	Qgs	_	21.6	_	nC		
Gate-Drain Charge	$Q_{qd}$	_	20.4	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	13.2	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 90A, R_{G} = 3.5\Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	11.7	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	31	_			
Turn-Off Fall Time	t <sub>F</sub>		12	_			
Reverse Recovery Time	t <sub>RR</sub>	_	50.5	_	ns	L 504 di/dt 4004/	
Reverse Recovery Charge	Q <sub>RR</sub>	-	80.8	_	nC	I <sub>F</sub> =50A, di/dt=100A/μs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect.

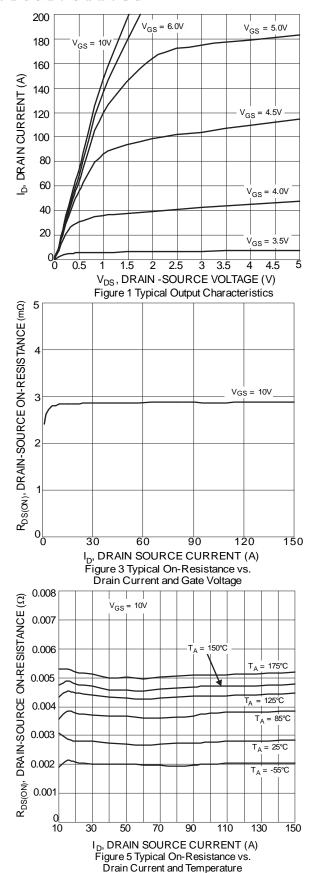
8. Guaranteed by design. Not subject to product testing.

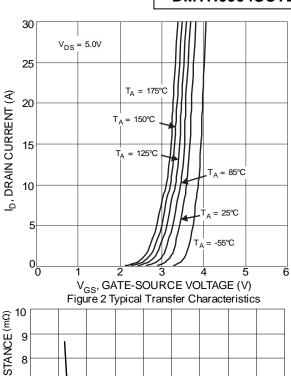
9. Package limited.

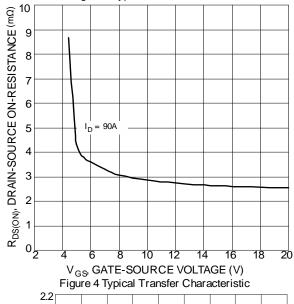
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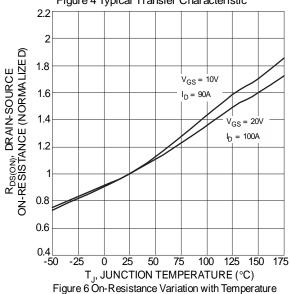




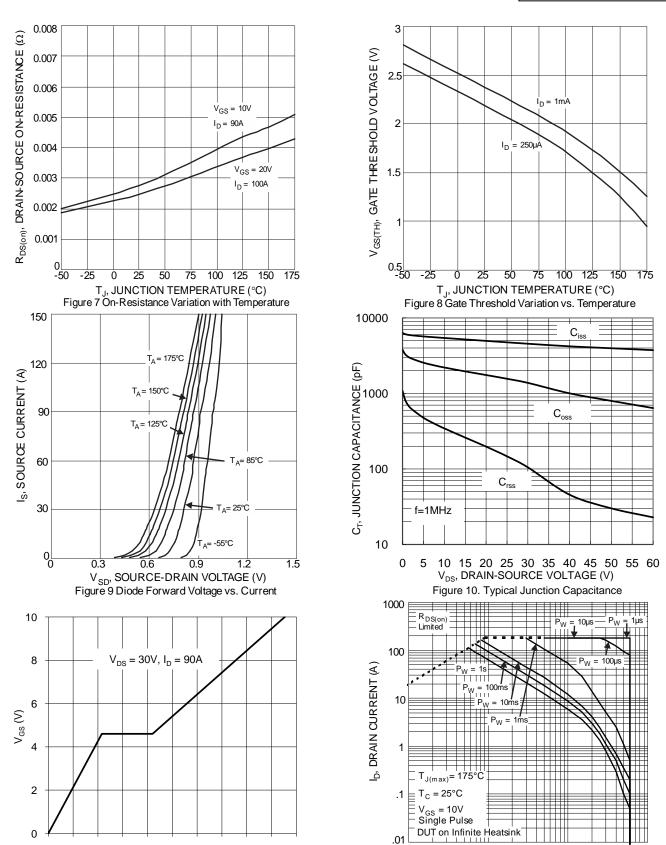












0 10

20 30 40

50

Qg (nC) Figure 11. Gate Charge

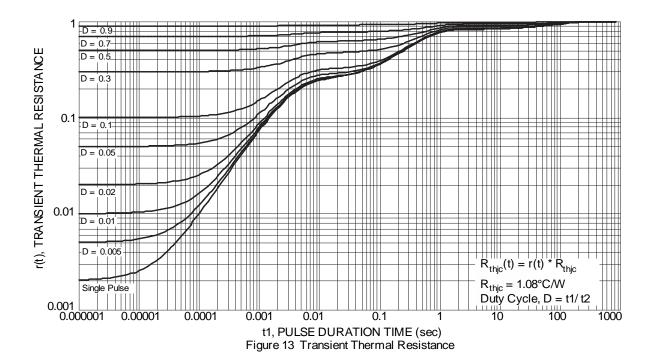
60 70

 $\rm V_{DS}$ , DRAIN-SOURCE VOLTAGE (V) Figure 12 SOA, Safe Operation Area

90 100

80

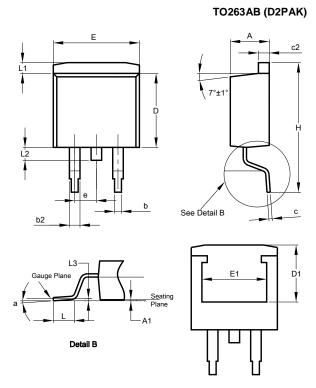






## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

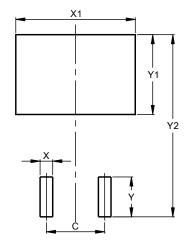


TO263AB (D2PAK)					
Dim	Min	Max	Тур		
Α	4.07	4.82	_		
<b>A</b> 1	0.00	0.25	_		
b	0.51	0.99	_		
b2	1.15	1.77	_		
С	0.356	0.73	_		
c2	1.143	1.65			
D	8.39	9.65	_		
D1	6.55	6.95	_		
е	2.54 TYP				
Е	9.66	9.66 10.66			
E1	6.23	8.23	_		
Н	14.61	15.87	_		
L	1.78	2.79	_		
L1	_	1.67	_		
L2	_	1.77	_		
L3	_	_	0.254		
а	0°	8°	_		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### TO263AB (D2PAK)



Dimensions	Value (in mm)		
С	5.08		
Х	1.10		
X1	10.41		
Υ	3.50		
Y1	7.01		
Y2	15 99		



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